



Features

- High frequency operation
- High surge forward current capability
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Solder dip 275 °C max. 7 s, per JESD 22-B106

Typical Applications

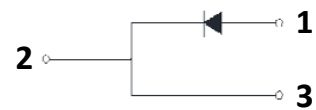
Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

Mechanical Data

- **Package:** TO-220C-2L
Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant
- **Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102
- **Polarity:** As marked



TO-220C-2L



Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	MUR810	MUR815	MUR820	MUR840	MUR860
Device marking code			MUR810	MUR815	MUR820	MUR840	MUR860
Repetitive Peak Reverse Voltage	VRRM	V	100	150	200	400	600
Average Rectified Output Current @60Hz half sine-wave, R-load, Tc(FIG.1)	Io	A	8				
Surge(Non-repetitive)Forward Current @60Hz half sine-wave,1 cycle, Ta=25°C	IFSM	A	100				
Current Squared Time @1ms≤t≤8.3ms Tj=25°C	I ² t	A ² s	41				
Storage Temperature	Tstg	°C	-55 ~ +150				
Junction Temperature	Tj	°C	-55 ~ +150				

Electrical Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	MUR810	MUR815	MUR820	MUR840	MUR860
Maximum instantaneous forward voltage drop per diode	VFM	V	IFM=8.0A	0.975			1.3	1.5
Maximum DC reverse current at rated DC blocking voltage per diode	IRRM1	uA	VRM=VRRM Ta=25°C	10				
	IRRM2		VRM=VRRM Ta=125°C	500				
Reverse Recovery Time	Trr	ns	IF=0.5A IRM=1A IRR=0.25A	50				

Thermal Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	MUR810	MUR815	MUR820	MUR840	MUR860
Thermal Resistance	Between junction and case	RθJ-C	°CW	2.0			



Characteristics (Typical)

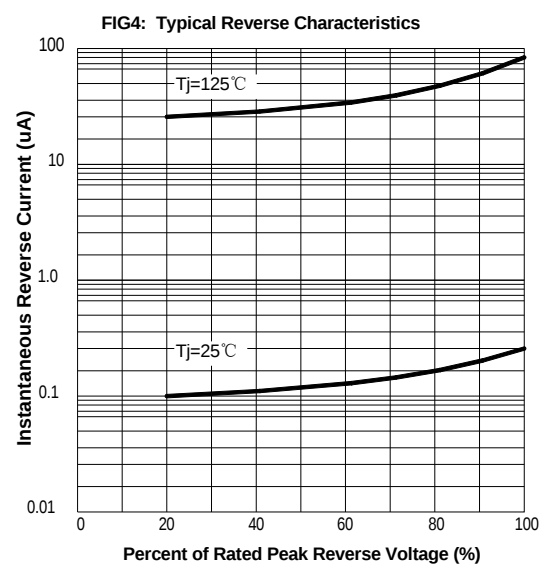
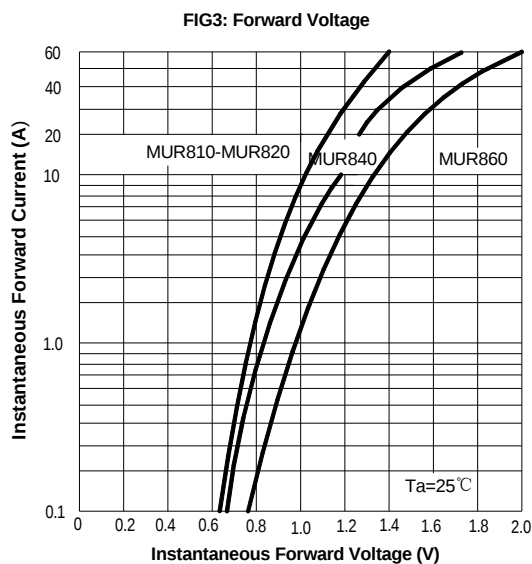
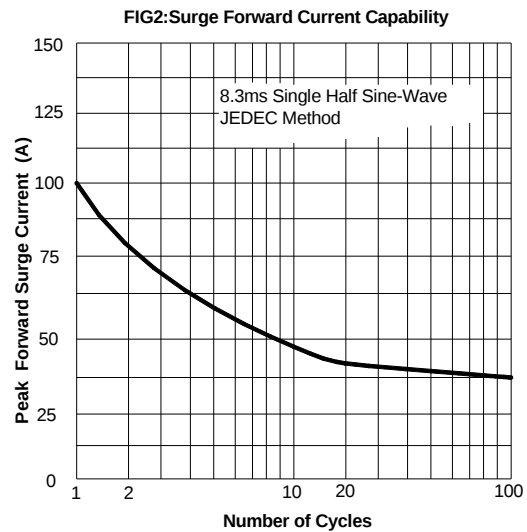
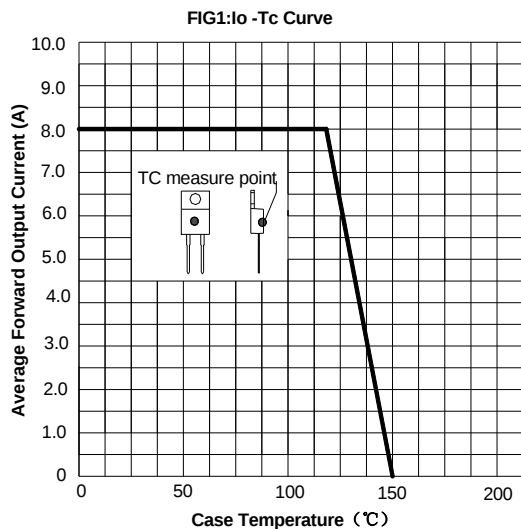
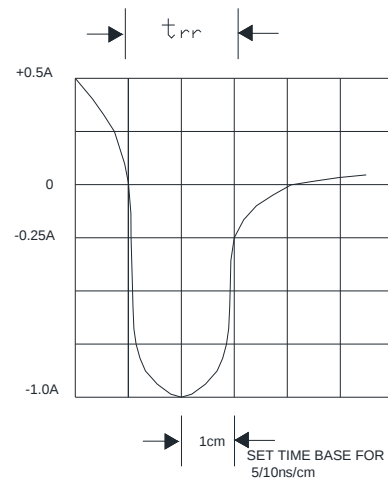
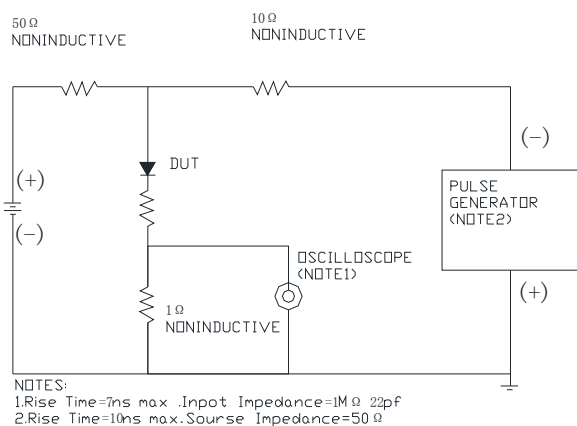


FIG.5 Diagram of circuit and Testing wave form of reverse recovery time





MUR810-MUR860

Package Information



SYMBOL	DIMENSIONS			NOTES
	MIN.	NOM.	MAX.	
A	4,24	4,44	4,64	
A1	1.15	1.27	1.40	
A2	2.30	2.48	2.70	
b	0.70	0.80	0.90	
b1	1.20	1.55	1.75	
b2	1,20	1,45	1,70	
c	0.40	0.50	0.60	
D	14,70	15,37	16,00	4
D1	8,82	8,92	9,02	
D2	12,43	12,73	12,83	5
E	9,96	10,16	10,36	4,5
E1	6,86	7,77	8,89	5
E3*	8,70REF.			
e	2,54BSC			
e1	5,08BSC			
H1	6,30	6,45	6,60	5,6
L	13,47	13,72	13,97	
L1	3.60	3.80	4.00	
∅P	3,75	3,84	3,93	
Q	2,60	2,80	3,00	
Q1*	1,73REF.			
R*	1,82REF.			



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